

## PMEG100T30ELP-Q

# 100 V, 3 A low leakage current Trench MEGA Schottky barrier rectifier

7 July 2021

Product data sheet

#### 1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP5 (SOD128) small and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Low forward voltage
- Low Q<sub>rr</sub> and low I<sub>RM</sub>
- · Low leakage current
- · High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

#### 3. Applications

- High efficiency DC-to-DC conversion
- · Automotive LED lighting
- Switch mode power supply
- · Freewheeling applications
- Reverse polarity protection
- OR-ing

#### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> $\leq$ 160 °C		-	-	3	Α
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	-	100	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	705	800	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 100 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	0.25	1.75	μΑ
		$V_R$ = 100 V; pulsed; $T_j$ = 125 °C	[1]	-	0.42	2.2	mA

<sup>[1]</sup> Very short pulse, in order to maintain a stable junction temperature.



#### 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		К <del>_[[-]</del> А
2	А	anode	1 2 CFP5 (SOD128)	sym001

<sup>[1]</sup> The marking bar indicates the cathode.

#### 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
PMEG100T30ELP-Q		plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG100T30ELP-Q	E5

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	100	V
I <sub>F</sub>	forward current	$\delta$ = 1; $T_{sp} \le 156 ^{\circ}\text{C}$		-	4.2	А
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 160 °C		-	3	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p = 8.3 \text{ ms}$ ; half sine wave; $T_{j(init)} = 25 \text{ °C}$		-	90	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	0.75	W
			[2]	-	1.2	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

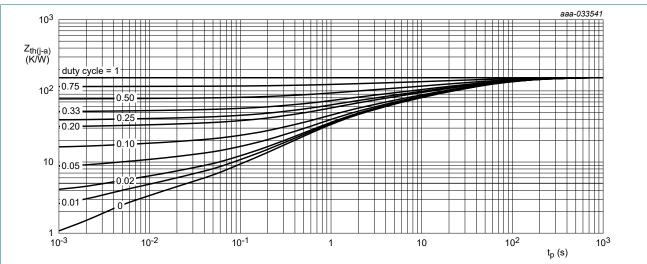
Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

#### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

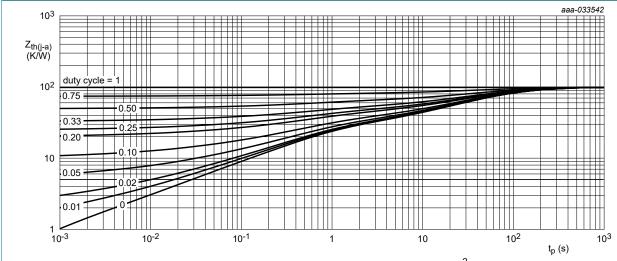
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1] [2]	-	-	200	K/W
jund	junction to ambient		[1] [3]	-	-	120	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[4]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.



FR4 PCB, single-sided copper, tin-plated and standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided copper, tin-plated and mounting pad for cathode 1 cm<sup>2</sup>

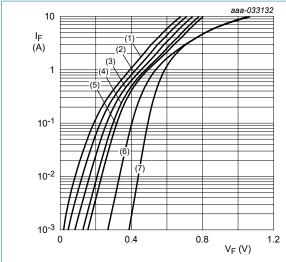
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

#### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>(BR)R</sub>	reverse breakdown voltage	I <sub>R</sub> = 1 mA; pulsed; T <sub>j</sub> = 25 °C	[1]	100	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.5 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	480	550	mV
		I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	540	610	mV
		I <sub>F</sub> = 2 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	630	710	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	705	800	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = -40 °C	[1]	-	705	800	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 125 °C	[1]	-	580	650	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 150 °C	[1]	-	545	620	mV
I <sub>R</sub>	reverse current	$V_R$ = 60 V; pulsed; $T_j$ = 25 °C	[1]	-	0.1	8.0	μΑ
		$V_R$ = 100 V; pulsed; $T_j$ = 25 °C	[1]	-	0.25	1.75	μΑ
		$V_R = 100 \text{ V}$ ; pulsed; $T_j = 125 \text{ °C}$	[1]	-	0.42	2.2	mA
		V <sub>R</sub> = 100 V; pulsed; T <sub>j</sub> = 150 °C	[1]	-	1.65	8	mA
$C_d$	diode capacitance	$V_R = 1 \text{ V; } f = 1 \text{ MHz; } T_j = 25 ^{\circ}\text{C}$		-	300	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	85	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(meas)} = 0.1 \text{ A}$ ; $I_{j} = 25 \text{ °C}$		-	9	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	12.5	-	ns
I <sub>RM</sub>	peak reverse recovery current	$dI_F/dt = 200 \text{ A/s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	1.3	-	А
Q <sub>rr</sub>	reverse recovery charge			-	10	-	nC
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/µs}; T_j = 25 °C$		-	480	-	mV

<sup>[1]</sup> Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) Tj = 175 °C

(2) Tj = 150 °C

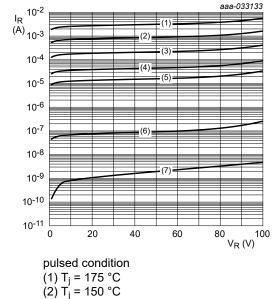
(3) Tj = 125 °C

(4) Tj = 100 °C

(5) Tj = 85 °C

(6) Tj = 25 °C (7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



 $(3) T_i = 125 °C$ 

 $(4) T_i = 100 °C$ 

 $(5) T_i = 85 ^{\circ}C$ (6)  $T_i = 25 \,^{\circ}\text{C}$ 

(7)  $T_i = -40$  °C

Fig. 4. Reverse current as a function of reverse voltage; typical values

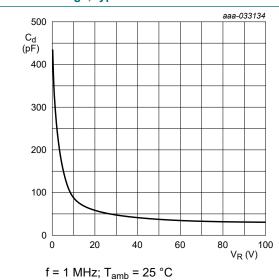
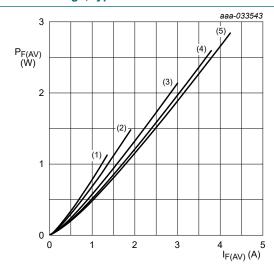


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



T<sub>i</sub> = 100 °C

 $(1) \delta = 0.1$ 

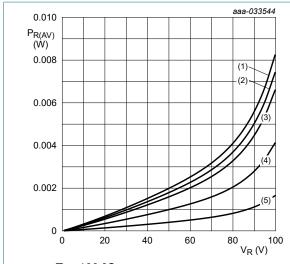
(2)  $\delta = 0.2$ 

 $(3) \delta = 0.5$ 

 $(4) \delta = 0.8$ 

(5)  $\delta = 1$ ; DC

Average forward power dissipation as a Fig. 6. function of average forward current; typical values



 $T_j = 100 \,{}^{\circ}C$ 

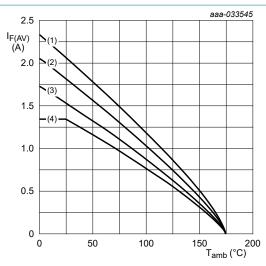
 $(1) \delta = 1; DC$ 

 $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$  $(4) \delta = 0.5$ 

 $(4) \delta = 0.3$  $(5) \delta = 0.2$ 

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T<sub>i</sub> = 175 °C

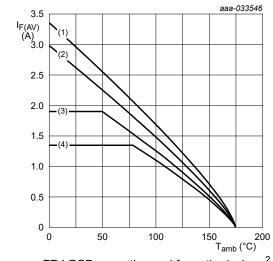
 $(1) \delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 175 °C

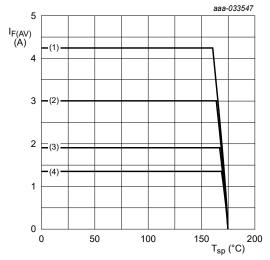
 $(1) \delta = 1; DC$ 

 $(2) \delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

(1)  $\delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

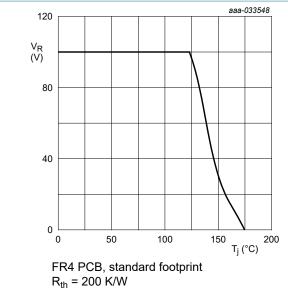
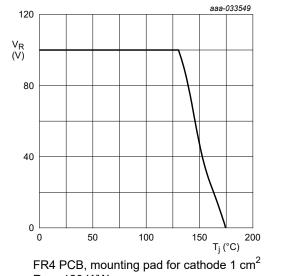
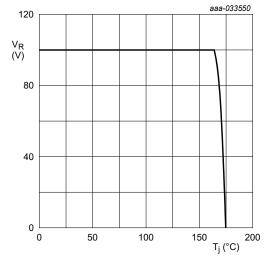


Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



 $R_{th} = 120 \text{ K/W}$ 

of junction temperature; typical values



Soldering point of cathode tab  $R_{th} = 12 \text{ K/W}$ 

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

#### 11. Test information

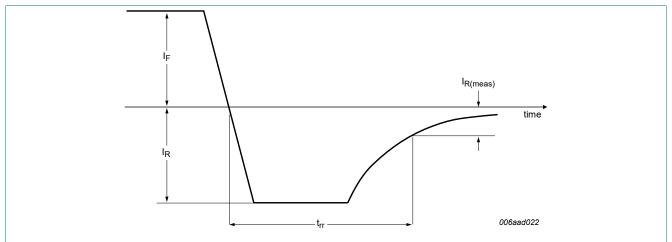


Fig. 14. Reverse recovery definition; step recovery

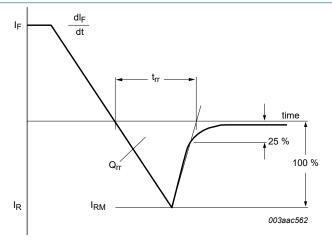


Fig. 15. Reverse recovery definition; ramp recovery

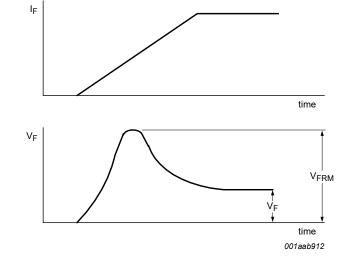
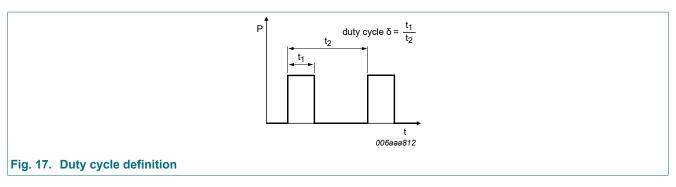


Fig. 16. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)}=I_M\times\delta$  with  $I_M$  defined as peak current

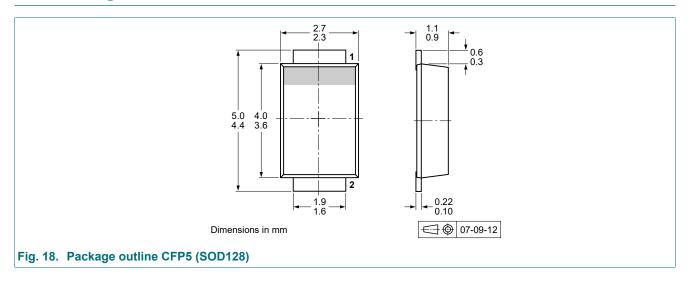
 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$ 

with  $I_{\mbox{\scriptsize RMS}}$  defined as RMS current.

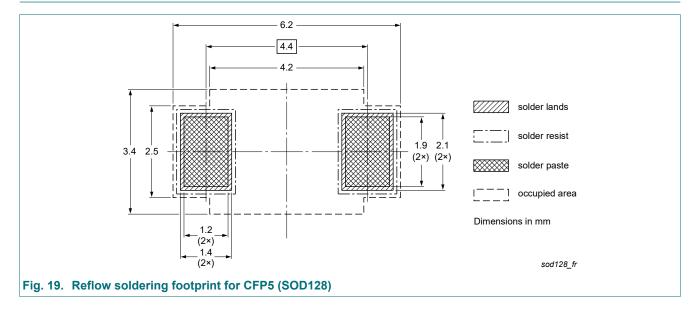
#### **Quality information**

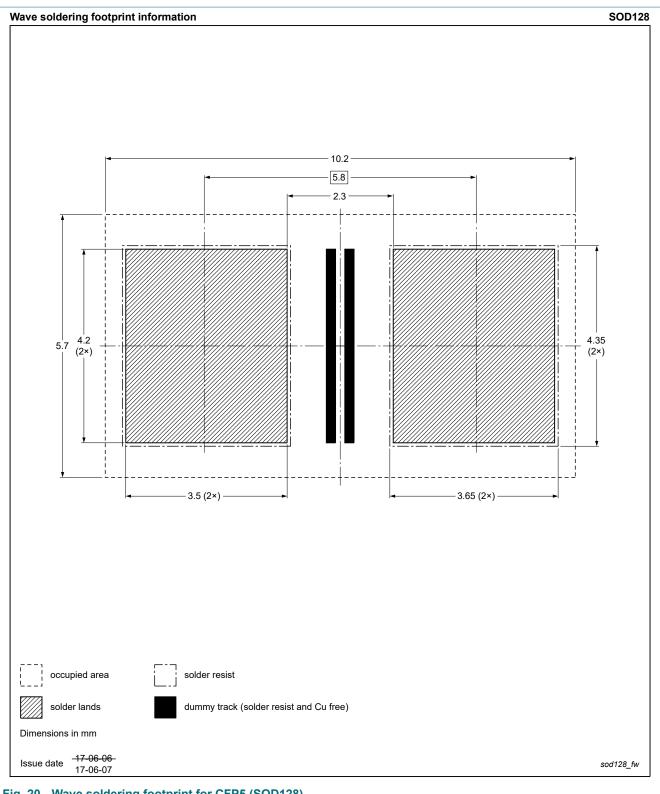
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

### 12. Package outline



#### 13. Soldering





11 / 14

## 14. Revision history

#### **Table 8. Revision history**

Data sheet ID	Release date		Change notice	Supersedes				
PMEG100T30ELP-Q v.2	20210707	Product data sheet	-	PMEG100T30ELP-Q v.1				
Modifications:	<ul> <li>Product statu</li> </ul>	s changed						
PMEG100T30ELP-Q v.1	20210608	Preliminary data sheet	-	-				

#### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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#### **Contents**

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	2
9.	Thermal characteristics	3
10.	. Characteristics	4
11.	Test information	8
12.	Package outline	10
	Soldering	
	Revision history	
	Legal information	
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